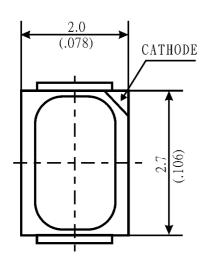


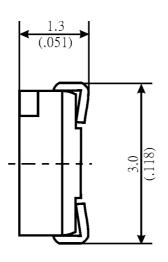
Property of Lite-On Only

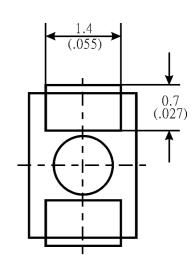
Features

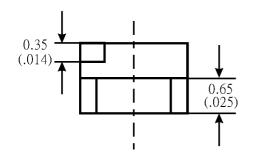
- * Package in 8mm tape on 7" diameter reels.
- * Compatible with automatic placement equipment.
- * Compatible with infrared and vapor phase reflow solder process.
- * EIA STD package.
- * I.C. compatible.
- * Lead Free Package(According to RoHS)

Package Dimensions

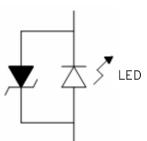












Part No.	Lens Color	Source Color
LTW-M670ZVA	Yellow	InGaN White

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.2 mm (.008") unless otherwise noted.





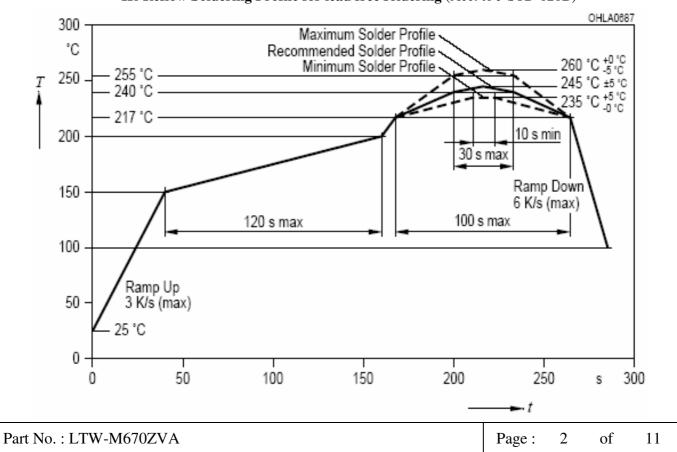
Property of Lite-On Only

Absolute Maximum Ratings at Ta=25℃

Parameter	LTW-M670ZVA	Unit	
Power Dissipation	120	mW	
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	100	mA	
DC Forward Current	30	mA	
Reverse Voltage	5	V	
Operating Temperature Range	-30°C to + 100°C		
Storage Temperature Range	-40°C to + 100°C		
Wave Soldering Condition	260°C For 5 Seconds		

Suggest IR Reflow Condition:

IR-Reflow Soldering Profile for lead free soldering (Acc. to J-STD-020B)





Electrical Optical Characteristics At Ta=25°C

Parameter	Symbol	Part No. LTW-	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	I_{V}	M670ZVA	1100	1300	1500	mcd	$I_{\rm F} = 20 \text{mA}$ Note 1, 2, 5
Luminous Flux	$\Phi_{ m V}$	M670ZVA		3550		mlm	$I_{\rm F} = 20 \text{mA}$ Note 1, 2, 5
Viewing Angle	2 θ 1/2	M670ZVA		120		deg	Fig.6
Chromaticity Coordinates	Х	M670ZVA		0.285			$I_{\rm F} = 20 \text{mA}$ Note 3, 5
Chromaticity Coordinates	У	WO/OZVA		0.270			Fig.1
Peak Wavelength	Wp	M670ZVA		445		nm	$I_{\rm F} = 20 { m mA}$
Forward Voltage	V_{F}	M670ZVA	3.0	3.3	3.6	V	$I_{\rm F} = 20 { m mA}$
ESD-Withstand Voltage	ESD	M670ZVA	8K			V	НВМ

Note: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

- 2. Iv classification code is marked on each packing bag.
- 3. The chromaticity coordinates (x, y) is derived from the 1931 CIE chromaticity diagram.
- 4. Caution in ESD:

Static Electricity and surge damages the LED. It is recommended using a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

- 5. CAS140B is the test standard for the chromaticity coordinates (x, y) & IV.
- 6. The chromaticity coordinates (x, y) guarantee should be added ± 0.01 tolerance.

Part No.: LTW-M670ZVA Page: 3 of 11



Property of Lite-On Only

Bin Code List

V _F Spec. Table					
VF Bin	Forward Voltage	Forward Voltage (V) at $I_F = 20 \text{mA}$			
VF DIII	Min.	Max.			
V1	3.0	3.1			
V2	3.1	3.2			
V3	3.2	3.3			
V4	3.3	3.4			
V5	3.4	3.5			
V6	3.5	3.6			

Tolerance on each Forward Voltage bin is +/-0.10 volt

	IV	Spec. Table	
IV/ D2	IV (mcd) a	at $I_{\rm F} = 20 \text{mA}$	Luminous Flux (mlm)
IV Bin	Min.	Max.	Тур.
R2	800	900	2300
R3	900	1000	2600
R4	1000	1100	2900
S1	1100	1200	3100
S2	1200	1300	3400
S3	1300	1400	3700
S4	1400	1500	4000

Tolerance on each Luminous Intensity bin is +/- 10%.

Color Ranks Table					
Ranks		Color bi	n limits at I	F = 20mA	
Kanks		CIE 1931C	hromaticity	coordinates	
A31	X	0.280	0.288	0.282	0.272
ASI	y	0.248	0.262	0.272	0.258
A32	X	0.288	0.296	0.291	0.282
A32	y	0.262	0.276	0.287	0.272
A33	X	0.272	0.282	0.276	0.264
1133	У	0.258	0.272	0.282	0.267
A34	X	0.282	0.291	0.287	0.276
AJŦ	У	0.272	0.287	0.295	0.282

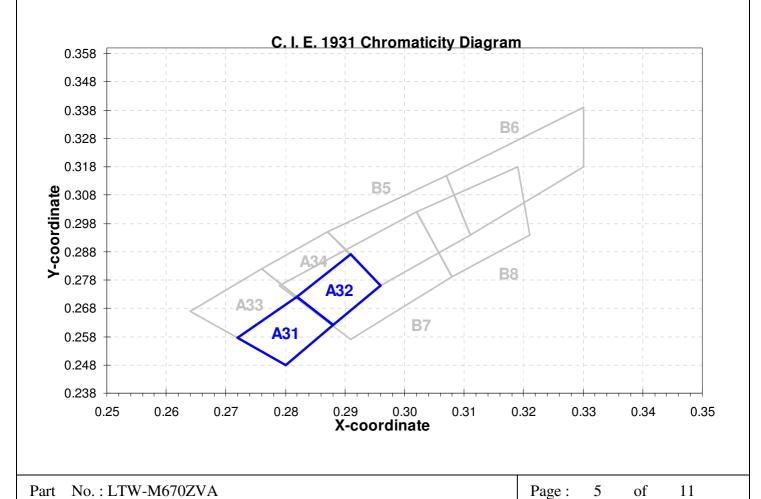
Part No.: LTW-M670ZVA Page: of 11



Property of Lite-On Only

	Color Ranks Table					
Ranks		Color bi	n limits at IF	= 20mA		
Kanks		CIE 1931C	hromaticity (coordinates		
B51	X	0.291	0.287	0.296	0.299	
DJI	У	0.287	0.295	0.304	0.294	
B52	X	0.302	0.299	0.309	0.311	
D32	У	0.283	0.294	0.305	0.294	
B53	X	0.291	0.287	0.296	0.299	
D55	у	0.287	0.295	0.304	0.294	
B54	X	0.299	0.296	0.307	0.309	
D34	У	0.294	0.304	0.315	0.305	
В6	X	0.291	0.287	0.296	0.299	
DO	У	0.287	0.295	0.304	0.294	
В7	X	0.302	0.299	0.309	0.311	
D/	У	0.283	0.294	0.305	0.294	
В8	X	0.291	0.287	0.296	0.299	
Do	У	0.287	0.295	0.304	0.294	

Tolerance on each Hue (x, y) bin is ± -0.01 .



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of

11

BNS-OD-C131/A4

Typical Electrical / Optical Characteristics Curves (25°C Ambient Temperature Unless Otherwise Noted)

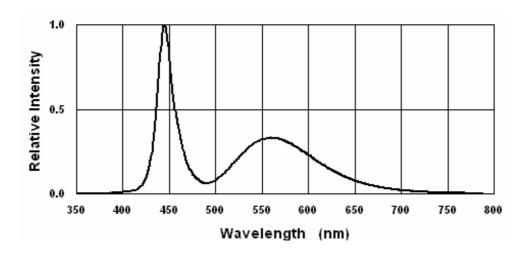
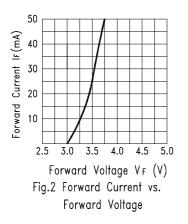
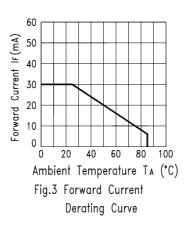
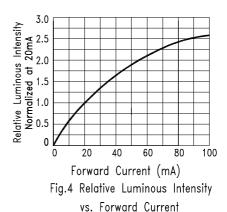
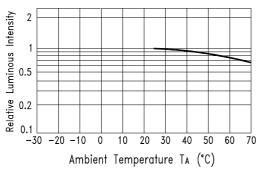


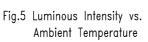
Fig.1 RELATIVE INTENSITY VS. WAVELENGTH











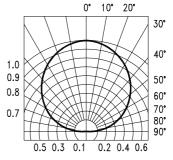


Fig.6 Spatial Distribution

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Property of Lite-On Only

User Guide

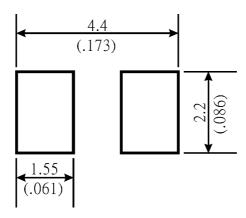
Cleaning

Do not use unspecified chemical liquid to clean LED they could harm the package.

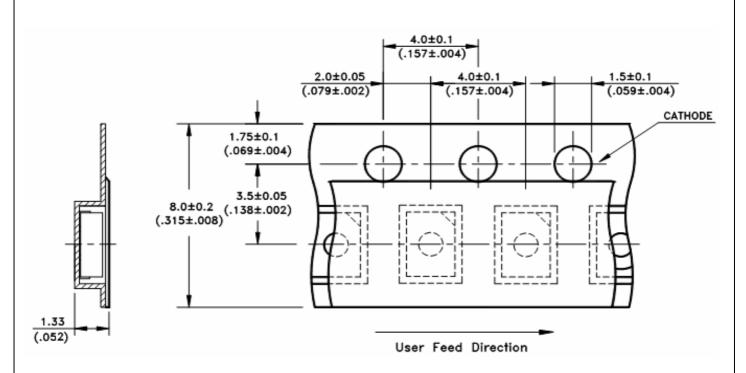
If cleaning is necessary, immerse the LED in ethyl alcohol or isopropyl alcohol at normal temperature for less than one minute.

Recommend Printed Circuit Board Attachment Pad

Infrared / vapor phase Reflow Soldering



Package Dimensions of Tape



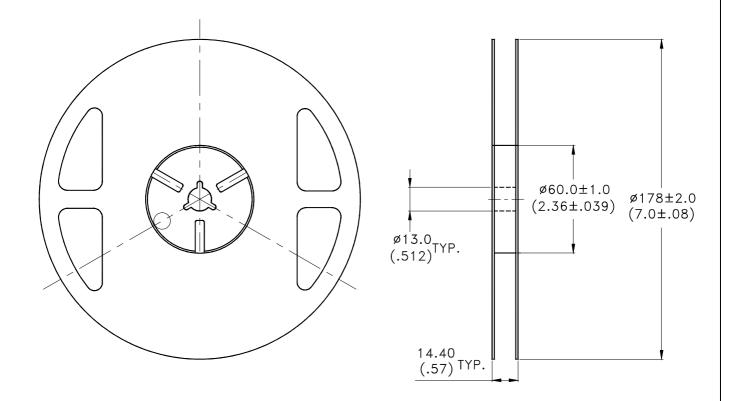
Note:

1. All dimensions are in millimeters (inches).



Property of Lite-On Only

Package Dimensions of Reel



Notes:

- 1. Empty component pockets sealed with top cover tape.
- 2. 7 inch reel-2000 pieces per reel.
- 3. Minimum packing quantity is 500 pieces for remainders.
- 4. The maximum number of consecutive missing lamps is two.
- 5. In accordance with EIA-481-1-B specifications.

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CAUTIONS

1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

2. Storage

The storage ambient for the LEDs should not exceed 85°C temperature or 60% relative humidity.

It is recommended that LEDs out of their original packaging are IR-reflowed within one week.

For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant, or in desiccators with nitrogen ambient.

LEDs stored out of their original packaging for more than a week should be baked at about 60 deg C for at least 24 hours before solder assembly.

3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED if necessary.

4. Soldering

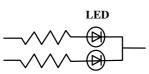
Recommended soldering conditions:

Reflow soldering		Wave Soldering		Soldering iron	
Pre-heat	120~150°C	Pre-heat	100°C Max.	Temperature	300°C Max.
Pre-heat time	120 sec. Max.	Pre-heat time	60 sec. Max.	Soldering time	3 sec. Max.
Soldering Temp.	260°C Max.	Solder wave	260°C Max.		(one time only)
Soldering time	30 sec. Max.	Soldering time	10 sec. Max.		

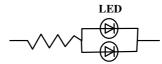
5. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

Circuit model A



Circuit model B



- (A) Recommended circuit.
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

6. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use of a conductive wrist band or anti-electrostatic glove when handling these LEDs.
- All devices, equipment, and machinery must be properly grounded.
- Work tables, storage racks, etc. should be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LED's plastic lens as a result of friction between LEDs during storage and handling.



ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or "no lightup" at low currents.

To verify for ESD damage, check for "light up" and Vf of the suspect LEDs at low currents.

The Vf of "good" LEDs should be >2.0V@0.1mA for InGaN product and >1.4V@0.1mA for AlInGaP product.

7. Reliability Test

Test Item	Test Condition	Reference Standard	Note	Number of Damaged
Resistance to Soldering Heat (Reflow Soldering)	Tsld=260°C, 10sec. (Pre treatment 30°C,70%,168hrs.)	JEITA ED-4701 300 301	2 times	0/50
Solderability (Reflow Soldering)	Tsld=245±5°C, 3sec. (Lead Free Solder)	JEITA ED-4701 300 303	1 time Over 95%	0/50
Thermal Shock	0°C ~ 100°C 15sec. 15sec	JEITA ED-4701 300 307	20 cycles	0/50
Temperature Cycle	-40°C ~ 25°C ~ 100°C ~ 25°C 30min. 5min. 30min. 5min.	JEITA ED-4701 100 105	100 cycles	0/50
Moisture Resistance Cyclic	25°C ~ 65°C ~ -10°C 90%RH 24HRS./1cycle	JEITA ED-4701 200 203	10 cycles	0/50
High Temperature Storage	Ta=100°C	JEITA ED-4701 200 201	1000 hrs.	0/50
Temperature Humidity Storage	Ta=60°C, RH=90%	JEITA ED-4701 100 103	1000 hrs.	0/50
Low Temperature Storage	Ta=-40°C	JEITA ED-4701 200 202	1000 hrs.	0/50
Steady State Operating Life Condition 1	Ta=25°C, IF=20mA		1000 hrs.	0/50
Steady State Operating Life Condition 2	Ta=25°C, IF=30mA		500 hrs.	0/50
Steady State Operating Life of High Temperature	Ta=85°C, IF=5mA		1000 hrs.	0/50
Steady State Operating Life of High Humidity Heat	60°C, RH=90%, IF=15mA		500 hrs.	0/50
Steady State Operating Life of low Temperature	Ta=-30℃, IF=20mA		1000 hrs.	0/50
Vibration	100~2000~100Hz Sweep 4 min. 200m/s ² 3 direction , 4 cycles	JEITA ED-4701 400 403	48 min.	0/50
Substrate Bending	3 mm, 5±1 sec.	JEITA ED-4702	1 time	0/50
Stick	5N, 10±1 sec.	JEITA ED-4702	1 time	0/50

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Property of Lite-On Only

8. Others

The appearance and specifications of the product may be modified for improvement without prior notice.

9. Quality Guarantee

LiteOn guarantee DPPM level of function failure is smaller and equal to 50 DPPM.

(Based on 100k usage)

10. Suggested Checking List

Training and Certification

- 1. Everyone working in a static-safe area is ESD-certified?
- 2. Training records kept and re-certification dates monitored?

Static-Safe Workstation & Work Areas

- 1. Static-safe workstation or work-areas have ESD signs?
- 2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 3. All ionizer activated, positioned towards the units?
- 4. Each work surface mats grounding is good?

Personnel Grounding

- 1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
- 2. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V*?
- 4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
- 5. All wrist strap or heel strap checkers calibration up to date? Note: *50V for Blue LED.

Device Handling

- 1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 4. All flexible conductive and dissipative package materials inspected before reuse or recycle?

Others

- 1. Audit result reported to entity ESD control coordinator?
- 2. Corrective action from previous audits completed?
- 3. Are audit records complete and on file?

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